

## TNG10N40PA

## **N-Channel Enhancement Mode Power MOSFET**

#### **Product Summary**

- V<sub>DS</sub>= 40V,I<sub>D</sub>= 10A
- $R_{DS(on)}$ < 12m $\Omega$  @ $V_{GS}$ = 10V
- $R_{DS(on)}$ <  $18m\Omega @V_{GS}$ = 4.5V

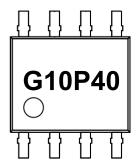
#### **Features**

- Advanced Split Gate Trench Technology
- 100% Avalanche Tested
- RoHS and Reach Compliant
- Halogen and Antimony Free
- Moisture Sensitivity Level 3

## **Application**

- Load Switch
- PWM Application
- Power Management

# Marking Code



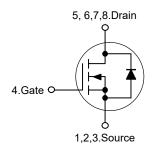


SOP-8

(Top View)

Pin	Description	
1,2,3	Source	
4	Gate	
5,6,7,8	Drain	

#### **Schematic Diagram**



#### **Absolute Maximum Ratings**

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	40	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	10	А
Drain Current-Pulsed Note1	I <sub>DM</sub>	25	Α
Maximum Power Dissipation	P <sub>D</sub>	20	W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

#### **Thermal Characteristics**

Thermal Resistance,Junction-to-Ambient Note2	R <sub>θJA</sub>	55	°C/W
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#### **Electrical Characteristics**

(T<sub>J</sub>=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μ <b>A</b>	40	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu$ A	1	1.5	2.0	V
		V <sub>GS</sub> =10V, I <sub>D</sub> =8A	-	9.5	12	mΩ
Drain-Source On-State Resistance	$R_{DS(ON)}$	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A	-	16	18	mΩ
Forward Transconductance	g <sub>FS</sub>	$V_{DS}=5V,I_{D}=8A$	33	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	$V_{DS}$ =20V, $V_{GS}$ =0V, F=1.0MHz	-	964	-	PF
Output Capacitance	C <sub>oss</sub>		-	109	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	96	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	5.5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =20V, $R_L$ =2.5 $\Omega$	-	14	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =3 $\Omega$	-	24	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	12	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =20V,I <sub>D</sub> =8A, V <sub>GS</sub> =10V	-	22.9	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	3.5	-	nC
Gate-Drain Charge	$Q_gd$		-	5.3	-	nC
Drain-Source Diode Characteristics			•	•		
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	$V_{GS}=0V,I_{S}=9A$	-	0.8	1.2	V

### **Typical Characteristic Curves**

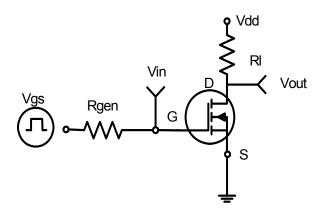
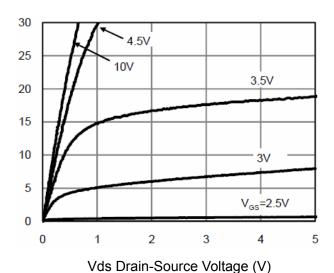


Figure 1:Switching Test Circuit



**Figure 3 Output Characteristics** 

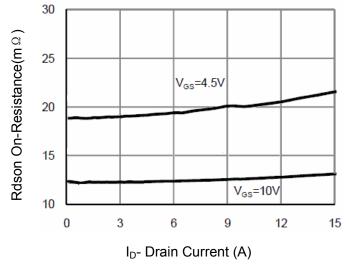
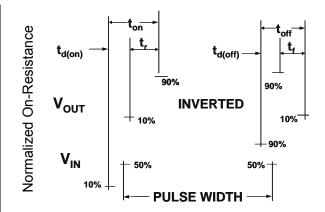
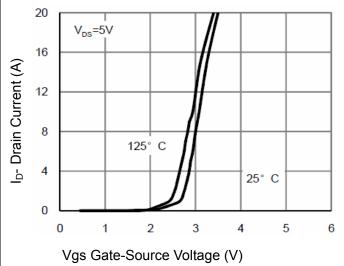


Figure 5 Drain-Source On-Resistance



**Figure 2:Switching Waveforms** 



**Figure 4 Transfer Characteristics** 

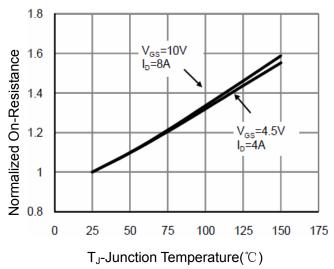
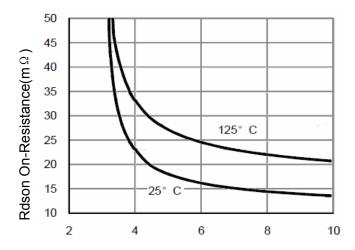


Figure 6 Drain-Source On-Resistance

#### **Typical Characteristic Curves**



Vgs Gate-Source Voltage (V)

## Figure7 Rdson vs Vgs

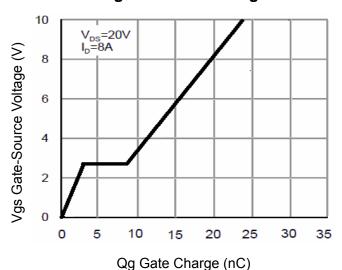


Figure 9 Gate Charge

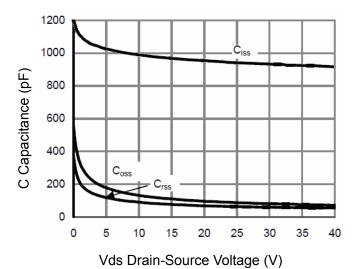
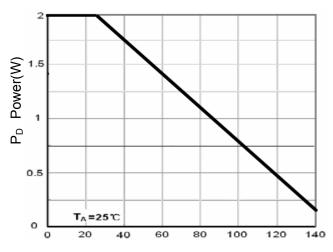


Figure 11 Capacitance vs Vds



T<sub>J</sub>-Junction Temperature(°C)

#### **Figure 8 Power Dissipation**

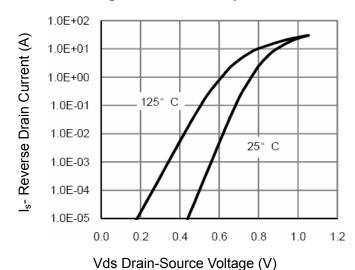
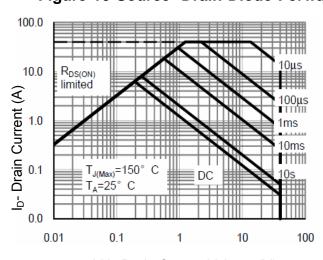


Figure 10 Source- Drain Diode Forward

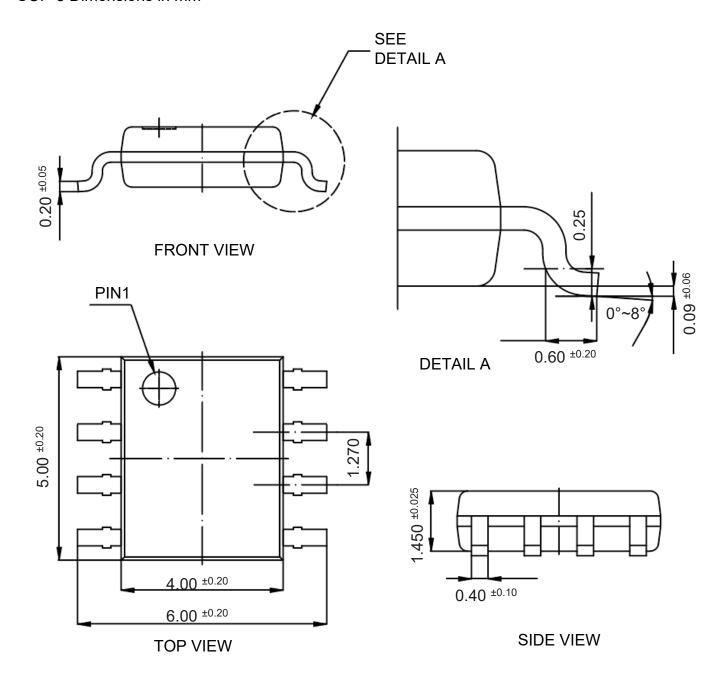


Vds Drain-Source Voltage (V)

**Figure 12 Safe Operation Area** 

## **Package Outline**

#### SOP-8 Dimensions in mm



#### **Ordering Information**

Device	Package	Shipping
TNG10N40PA	SOP-8	4,000PCS/Reel&13inches

#### **Contact Information**

TANI website: http://www.tanisemi.com Email:tani@tanisemi.com

For additional information, please contact your local Sales Representative.



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#### **Product Specification Statement**

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